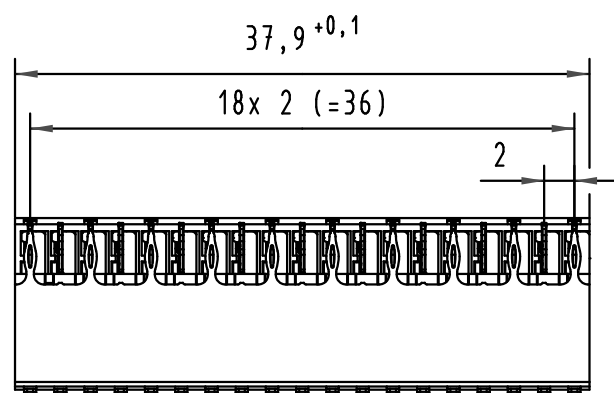
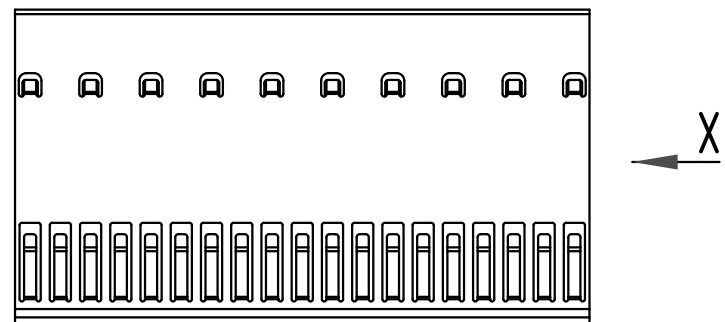
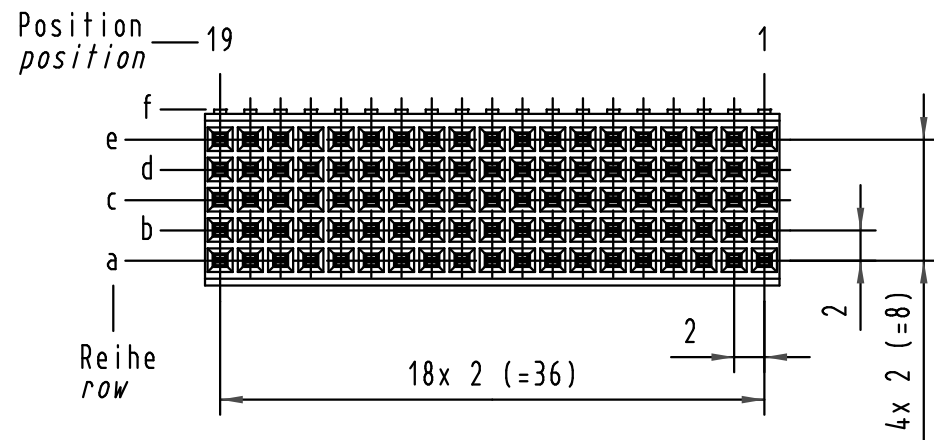
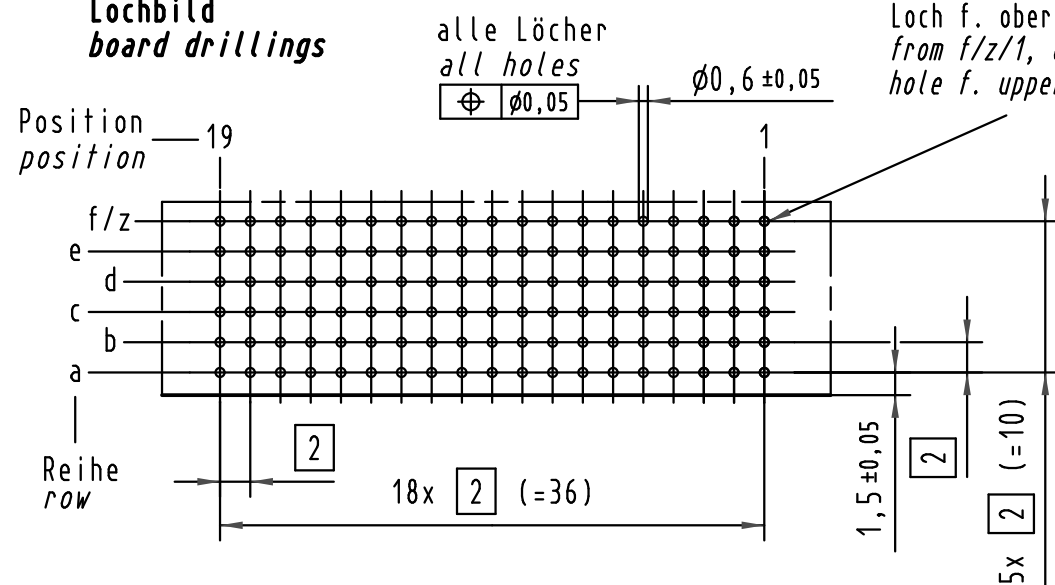


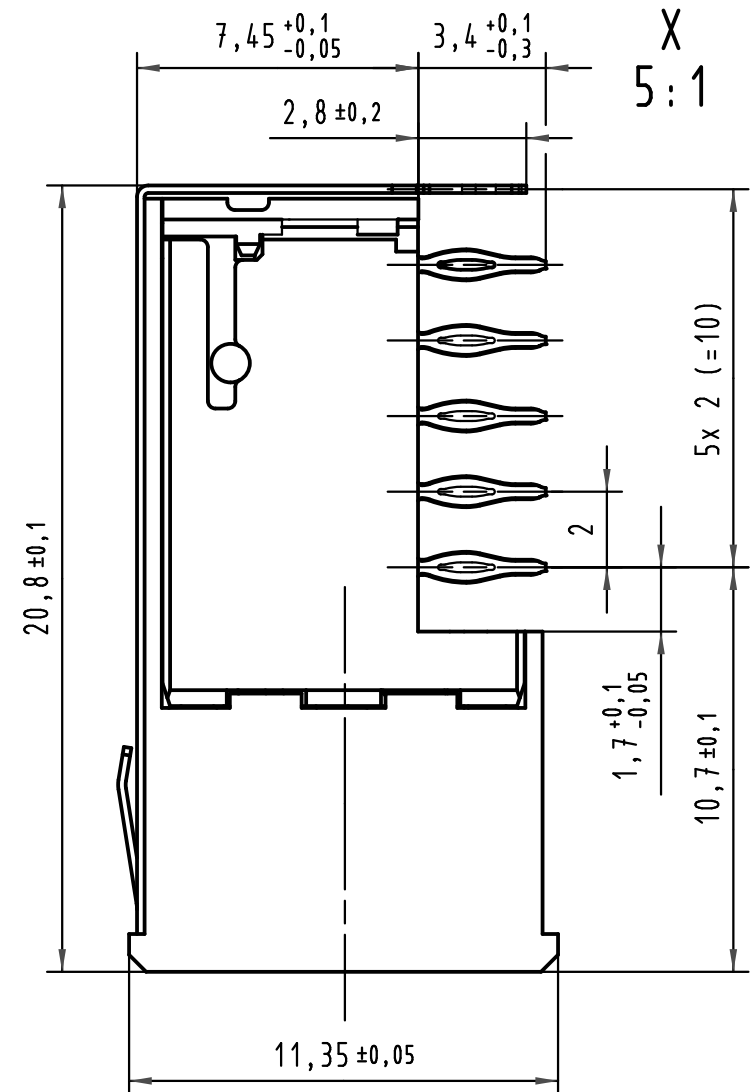
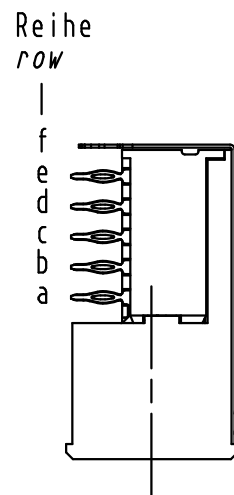
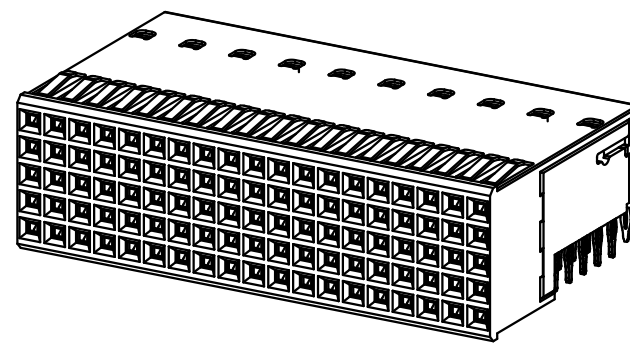


**Lochbild
board drillings**



Von f/z/1 aus, jedes 2.
Loch f. obere Abschirmung
from f/z/1, each 2nd
hole f. upper shielding

Bohrlochdurchmesser: $\varnothing 0,7 \pm 0,02$ mm
Lochdurchmesser (mit Oberfläche): $\varnothing 0,6 \pm 0,05$ mm
drill hole dia.: $\varnothing 0,7 \pm 0,02$ mm
through hole dia. (after plating): $\varnothing 0,6 \pm 0,05$ mm



17 25 095 4102	—	min.0,76µm (30µm) Au über/over min.1,27µm (50µm) Ni
17 25 095 2102	2	Au über/over Ni
17 25 095 1102	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

			All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maß/Free size tolerances IEC 61076-4-101		
				Dat.	Name	Maßstab/Scale 2:1 (5:1)	har-bus HM Federleiste, Typ B-19, 95 pol. mit Schirmblech Reihe-f <i>har-bus HM female connector, type B-19, 95 pol. with shield row-f</i>				
35456	01.12.08	TD	Detail.	30.06.99	Hm						
32387	18.11.04	HL.	Insp.	30.06.99	Ko						
29412	07.05.01	Lk	Stand.								
28494	21.09.00	Koe	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP				TB 17 25 095 x102			Blatt/ page /	
25016											
Mod.	Dat.	Name									